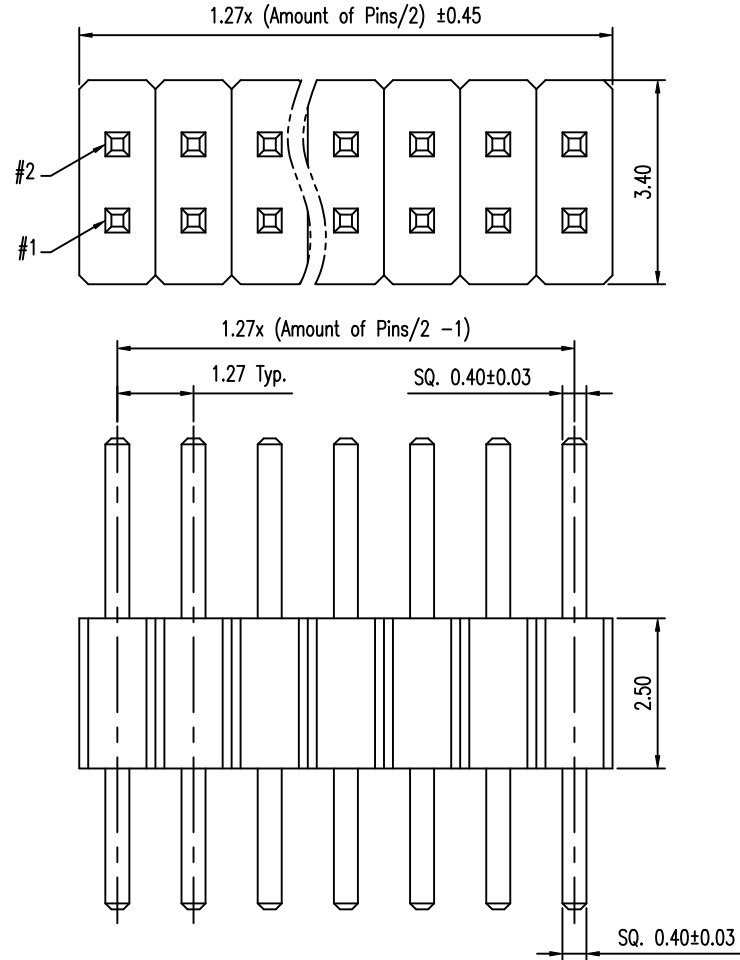


Recommended P.C.B. Layout
Layout Tolerance = ± 0.05 mm

NOTE:

1. MATERIAL,
HOUSING: HIGH TEMP PLASTIC, UL94-V0, BLACK
TERMINAL: COPPER ALLOY , SQ=0.40±0.03MM
2. FINISH:
TERMINAL: GOLD AT CONTACT,
G/F OVER 1um(40u")MIN Ni OVER ALL
3. SPEC.:
PRODUCT SPEC: GS-12-629
PACKING SPEC: GS-14-1420
4. THE HSG. WILL WITHSTAND EXPOSURE TO 260C
PEAK TEMP. FOR 5 SEC. IN A WAVE SOLDER APPLICATION
WITH A PCB.
5. PRODUCT NUMBERING:
20021111 - 0 0 0 XX X X LF

LEAD FREE

PLATING:
1: GOLD FLASH, ALL OVER
4: 0.25um(10U")GOLD AT CONTACT
8: 0.76um(30U")GOLD AT CONTACT
PACKING
T: TUBE

PIN COUNT
06,08,10,...., 98,A0
(6 -100 EVERY EVEN PIN)

mat'l. code				tolerances unless otherwise specified			CUSTOMER COPY		FCI 		www.fciconnect.com			
ltr	ecn no	dr	date	linear	.X ± 0.38			projection 	title 1.27X1.27MM BTB,HEADER UNSHROUDED,VERTICAL,TH					
A	T09-1117	S.LIN	09/15/09		.XX ± 0.25									
B	T10-0011	S.LIN	01/22/10		.XXX ± 0.10									
				angles	0° ±2°									
				dr	STERLING LIN	09/15/09	MM ↔	product family 585			code			
				engr	STERLING LIN	09/15/09		size dwg no			TWN			
				chr	GARY HSIEH	09/15/09								
				appd	JOSEPH HSIA	09/15/09	scale NA	A4	20021111			sheet 1 of 1		
sheet index		revision sheet		B 1										